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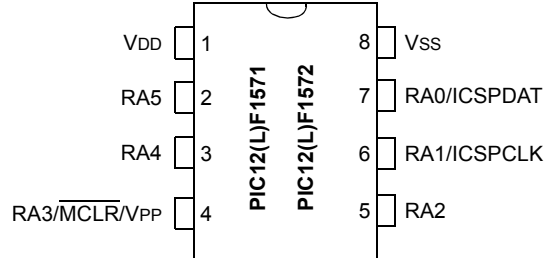
Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	6
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 4x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.154", 3.90mm Width)
Supplier Device Package	8-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic12lf1571t-i-sn

PIN DIAGRAMS

Pin Diagram – 8-Pin PDIP, SOIC, DFN, MSOP, UDFN



Note: See Table 1 for location of all peripheral functions.

TABLE 1: 8-PIN ALLOCATION TABLE (PIC12(L)F1571/2)

I/O	8-Pin PDIP/SOIC/MSOP/DFN/UDFN	ADC	Reference	Comparator	Timers	PWM	EUSART ⁽²⁾	CWG	Interrupt	Pull-up	Basic
RA0	7	AN0	DAC1OUT	C1IN+	—	PWM2	TX ⁽²⁾ CK ⁽²⁾	CWG1B	IOC	Y	ICSPDAT ICDDAT
RA1	6	AN1	VREF+	C1IN0-	—	PWM1	RX ⁽²⁾ DT ⁽²⁾	—	IOC	Y	ICSPCLK ICDCLK
RA2	5	AN2	—	C1OUT	T0CKI	PWM3	—	$\overline{\text{CWG1FLT}}$ CWG1A	IOC INT	Y	—
RA3	4	—	—	—	T1G ⁽¹⁾	—	—	—	IOC	Y	$\overline{\text{MCLR}}$ V _{PP}
RA4	3	AN3	—	C1IN1-	T1G	PWM2 ⁽¹⁾	TX ^(1,2) CK ^(1,2)	CWG1B ⁽¹⁾	IOC	Y	CLKOUT
RA5	2	—	—	—	T1CKI	PWM1 ⁽¹⁾	RX ^(1,2) DT ^(1,2)	CWG1A ⁽¹⁾	IOC	Y	CLKIN
VDD	1	—	—	—	—	—	—	—	—	—	VDD
VSS	8	—	—	—	—	—	—	—	—	—	VSS

Note 1: Alternate pin function selected with the APFCON (Register 11-1) register.

Note 2: PIC12(L)F1572 only.

2.1 Automatic Interrupt Context Saving

During interrupts, certain registers are automatically saved in shadow registers and restored when returning from the interrupt. This saves stack space and user code. See **Section 7.5 “Automatic Context Saving”**, for more information.

2.2 16-Level Stack with Overflow and Underflow

These devices have a hardware stack memory, 15 bits wide and 16 words deep. A Stack Overflow or Underflow will set the appropriate bit (STKOVF or STKUNF) in the PCON register, and if enabled, will cause a Software Reset. See **Section 3.5 “Stack”** for more details.

2.3 File Select Registers

There are two 16-bit File Select Registers (FSR). FSRs can access all file registers and program memory, which allows one Data Pointer for all memory. When an FSR points to program memory, there is one additional instruction cycle in instructions using INDF to allow the data to be fetched. General purpose memory can now also be addressed linearly, providing the ability to access contiguous data larger than 80 bytes. There are also new instructions to support the FSRs. See **Section 3.6 “Indirect Addressing”** for more details.

2.4 Instruction Set

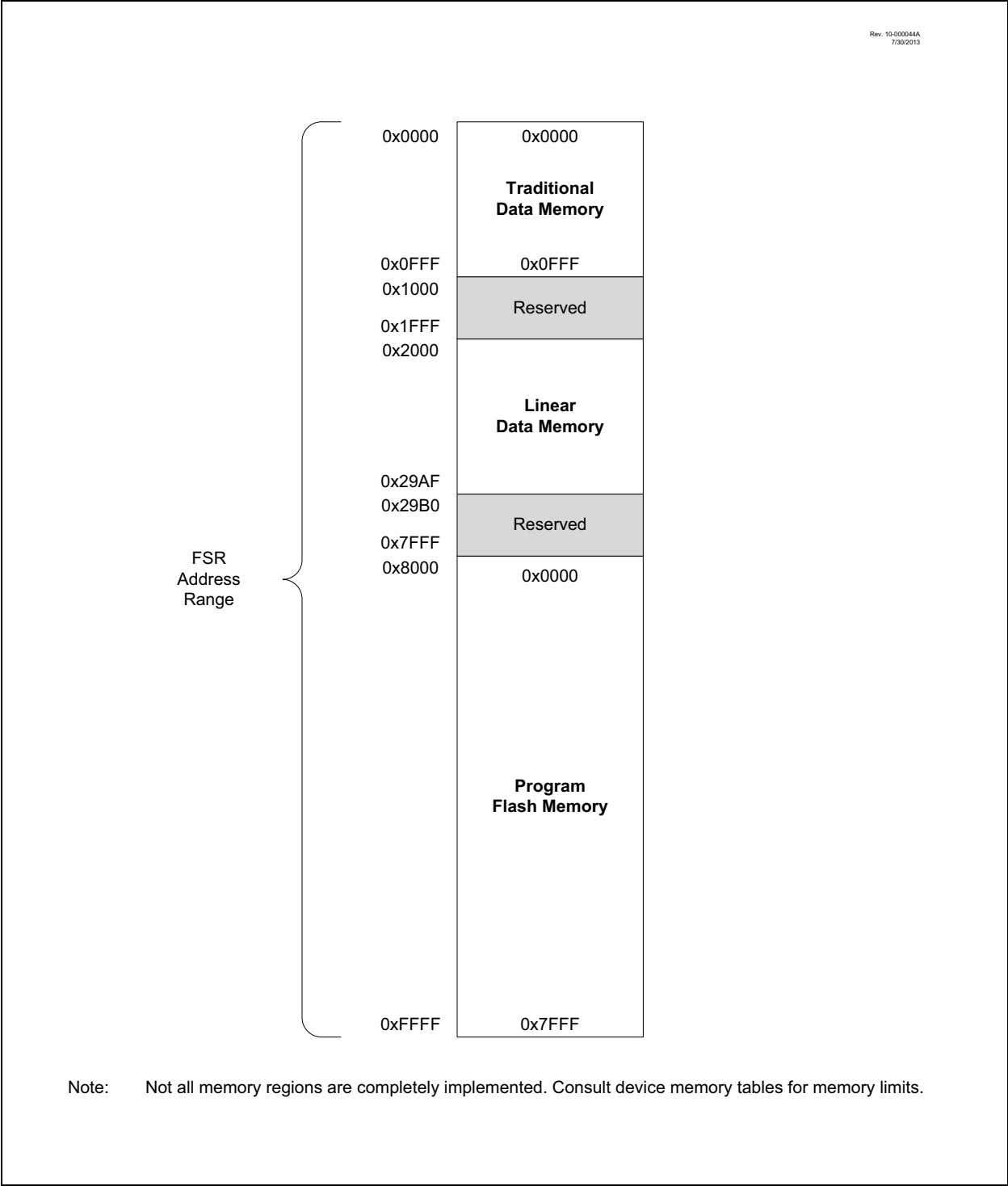
There are 49 instructions for the enhanced mid-range CPU to support the features of the CPU. See **Section 25.0 “Instruction Set Summary”** for more details.

TABLE 3-6: PIC12(L)F1571/2 MEMORY MAP, BANK 24-31

BANK 24				BANK 25				BANK 26				BANK 27				BANK 28				BANK 29				BANK 30				BANK 31			
C00h	Core Registers (Table 3-2)	C80h	Core Registers (Table 3-2)	D00h	Core Registers (Table 3-2)	D80h			Core Registers (Table 3-2)	D80h		E00h	Core Registers (Table 3-2)	E80h	Core Registers (Table 3-2)	F00h	Core Registers (Table 3-2)	F80h	Core Registers (Table 3-2)												
C0Bh		C8Bh		D0Bh		D8Bh				D8Bh		E0Bh		E8Bh		F0Bh		F8Bh													
C0Ch	—	C8Ch	—	D0Ch	—	D8Ch						E0Ch	—	E8Ch	—	F0Ch	—	F8Ch													
C0Dh	—	C8Dh	—	D0Dh	—							E0Dh	—	E8Dh	—	F0Dh	—														
C0Eh	—	C8Eh	—	D0Eh	—							E0Eh	—	E8Eh	—	F0Eh	—														
C0Fh	—	C8Fh	—	D0Fh	—							E0Fh	—	E8Fh	—	F0Fh	—														
C10h	—	C90h	—	D10h	—							E10h	—	E90h	—	F10h	—														
C11h	—	C91h	—	D11h	—							E11h	—	E91h	—	F11h	—														
C12h	—	C92h	—	D12h	—							E12h	—	E92h	—	F12h	—														
C13h	—	C93h	—	D13h	—							E13h	—	E93h	—	F13h	—														
C14h	—	C94h	—	D14h	—							E14h	—	E94h	—	F14h	—														
C15h	—	C95h	—	D15h	—							E15h	—	E95h	—	F15h	—														
C16h	—	C96h	—	D16h	—							E16h	—	E96h	—	F16h	—														
C17h	—	C97h	—	D17h	—							E17h	—	E97h	—	F17h	—														
C18h	—	C98h	—	D18h	—							E18h	—	E98h	—	F18h	—														
C19h	—	C99h	—	D19h	—							E19h	—	E99h	—	F19h	—														
C1Ah	—	C9Ah	—	D1Ah	—							E1Ah	—	E9Ah	—	F1Ah	—														
C1Bh	—	C9Bh	—	D1Bh	—							E1Bh	—	E9Bh	—	F1Bh	—														
C1Ch	—	C9Ch	—	D1Ch	—							E1Ch	—	E9Ch	—	F1Ch	—														
C1Dh	—	C9Dh	—	D1Dh	—							E1Dh	—	E9Dh	—	F1Dh	—														
C1Eh	—	C9Eh	—	D1Eh	—							E1Eh	—	E9Eh	—	F1Eh	—														
C1Fh	—	C9Fh	—	D1Fh	—							E1Fh	—	E9Fh	—	F1Fh	—														
C20h	Unimplemented Read as '0'	CA0h	Unimplemented Read as '0'	D20h	Unimplemented Read as '0'							E20h	Unimplemented Read as '0'	EA0h	Unimplemented Read as '0'	F20h	Unimplemented Read as '0'														
C6Fh		CEFh		D6Fh		DEFh						E6Fh		EEFh		F6Fh		FEFh													
C70h	Accesses 70h-7Fh	CF0h	Accesses 70h-7Fh	D70h	Accesses 70h-7Fh	DF0h	Accesses 70h-7Fh					E70h	Accesses 70h-7Fh	EF0h	Accesses 70h-7Fh	F70h	Accesses 70h-7Fh	FF0h	Accesses 70h-7Fh												
CFFh		CFFh		D7Fh		DFh						E7Fh		EFFh		F7Fh		FFh													

Legend: = Unimplemented data memory locations, read as '0'.

FIGURE 3-9: INDIRECT ADDRESSING



5.2.2.7 32 MHz Internal Oscillator Frequency Selection

The internal oscillator block can be used with the 4x PLL associated with the external oscillator block to produce a 32 MHz internal system clock source. The following settings are required to use the 32 MHz internal clock source:

- The FOSC_x bits in the Configuration Words must be set to use the INTOSC source as the device system clock (FOSC<1:0> = 00).
- The SCS_x bits in the OSCCON register must be cleared to use the clock determined by FOSC<1:0> in the Configuration Words (SCS<1:0> = 00).
- The IRCF_x bits in the OSCCON register must be set to the 8 MHz HFINTOSC to use (IRCF<3:0> = 1110).
- The SPLLEN bit in the OSCCON register must be set to enable the 4x PLL or the PLEN bit of the Configuration Words must be programmed to a '1'.

Note: When using the PLEN bit of the Configuration Words, the 4x PLL cannot be disabled by software and the 8 MHz HFINTOSC option will no longer be available.

The 4x PLL is not available for use with the internal oscillator when the SCS_x bits of the OSCCON register are set to '1x'. The SCS_x bits must be set to '00' to use the 4x PLL with the internal oscillator.

5.2.2.8 Internal Oscillator Clock Switch Timing

When switching between the HFINTOSC, MFINTOSC and the LFINTOSC, the new oscillator may already be shut down to save power (see Figure 5-3). If this is the case, there is a delay after the IRCF<3:0> bits of the OSCCON register are modified before the frequency selection takes place. The OSCSTAT register will reflect the current active status of the HFINTOSC, MFINTOSC and LFINTOSC oscillators. The sequence of a frequency selection is as follows:

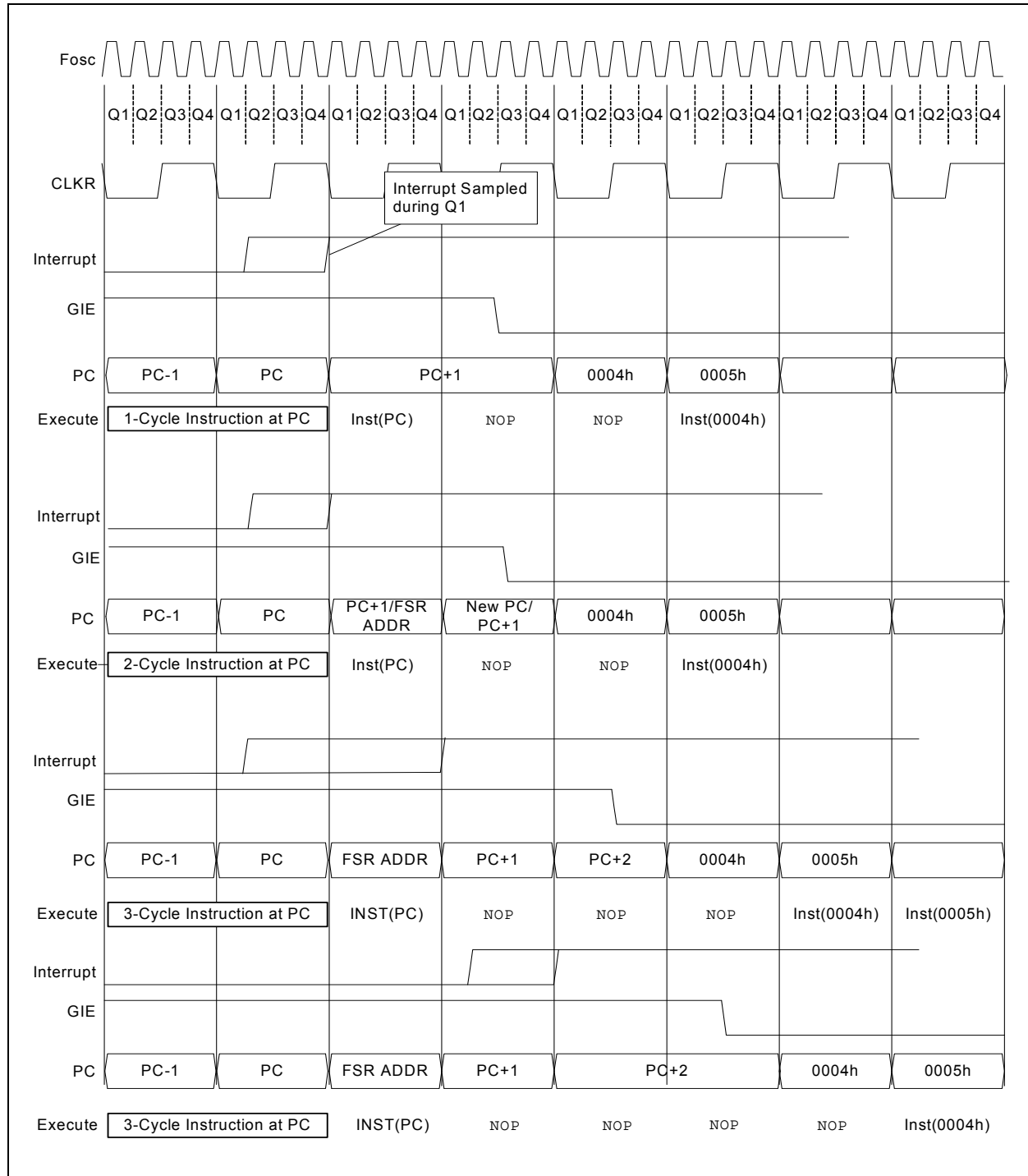
1. IRCF<3:0> bits of the OSCCON register are modified.
2. If the new clock is shut down, a clock start-up delay is started.
3. Clock switch circuitry waits for a falling edge of the current clock.
4. The current clock is held low and the clock switch circuitry waits for a rising edge in the new clock.
5. The new clock is now active.
6. The OSCSTAT register is updated as required.
7. Clock switch is complete.

See Figure 5-3 for more details.

If the internal oscillator speed is switched between two clocks of the same source, there is no start-up delay before the new frequency is selected. Clock switching time delays are shown in Table 5-1.

Start-up delay specifications are located in the oscillator tables of **Section 26.0 "Electrical Specifications"**.

FIGURE 7-2: INTERRUPT LATENCY



8.3 Register Definitions: Voltage Regulator Control

REGISTER 8-1: VREGCON: VOLTAGE REGULATOR CONTROL REGISTER⁽¹⁾

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0/0	R/W-1/1
—	—	—	—	—	—	VREGPM	Reserved
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

u = Bit is unchanged

x = Bit is unknown

U = Unimplemented bit, read as '0'

'1' = Bit is set

'0' = Bit is cleared

-n/n = Value at POR and BOR/Value at all other Resets

bit 7-2 **Unimplemented:** Read as '0'

bit 1 **VREGPM:** Voltage Regulator Power Mode Selection bit

1 = Low-Power Sleep mode enabled in Sleep⁽²⁾

Draws lowest current in Sleep, slower wake-up.

0 = Normal power mode enabled in Sleep⁽²⁾

Draws higher current in Sleep, faster wake-up.

bit 0 **Reserved:** Read as '1', maintain this bit set

Note 1: PIC12F1571/2 only.

2: See **Section 26.0 “Electrical Specifications”**

TABLE 8-1: SUMMARY OF REGISTERS ASSOCIATED WITH POWER-DOWN MODE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	TMR0IE	INTE	IOCFIE	TMR0IF	INTF	IOCFIF	74
IOCAF	—	—	IOCAF5	IOCAF4	IOCAF3	IOCAF2	IOCAF1	IOCAF0	122
IOCAN	—	—	IOCAN5	IOCAN4	IOCAN3	IOCAN2	IOCAN1	IOCAN0	121
IOCAP	—	—	IOCAP5	IOCAP4	IOCAP3	IOCAP2	IOCAP1	IOCAP0	121
PIE1	TMR1GIE	ADIE	RCIE ⁽¹⁾	TXIE ⁽¹⁾	—	—	TMR2IE	TMR1IE	75
PIE2	—	—	C1IE	—	—	—	—	—	76
PIE3	—	PWM3IE	PWM2IE	PWM1IE	—	—	—	—	77
PIR1	TMR1GIF	ADIF	RCIF ⁽¹⁾	TXIF ⁽¹⁾	—	—	TMR2IF	TMR1IF	78
PIR2	—	—	C1IF	—	—	—	—	—	79
PIR3	—	PWM3IF	PWM2IF	PWM1IF	—	—	—	—	80
STATUS	—	—	—	\overline{TO}	\overline{PD}	Z	DC	C	19
WDTCON	—	—	WDTPS<4:0>					SWDTEN	89

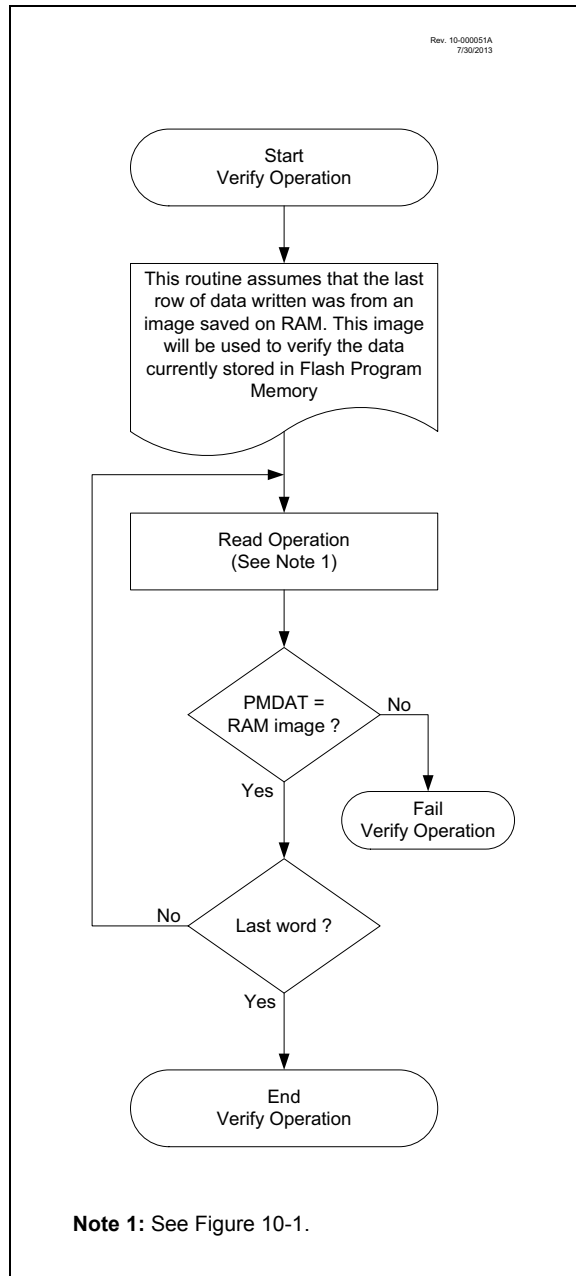
Legend: — = unimplemented, read as '0'. Shaded cells are not used in Power-Down mode.

Note 1: PIC12(L)F1572 only.

10.5 Write Verify

It is considered good programming practice to verify that program memory writes agree with the intended value. Since program memory is stored as a full page then the stored program memory contents are compared with the intended data stored in RAM after the last write is complete.

FIGURE 10-8: FLASH PROGRAM MEMORY VERIFY FLOWCHART



11.3 PORTA Registers

11.3.1 DATA REGISTER

PORTA is a 6-bit wide, bidirectional port. The corresponding Data Direction register is TRISA (Register 11-3). Setting a TRISA bit (= 1) will make the corresponding PORTA pin an input (i.e., disable the output driver). Clearing a TRISA bit (= 0) will make the corresponding PORTA pin an output (i.e., enables output driver and puts the contents of the output latch on the selected pin). The exception is RA3, which is input-only and its TRISA bit will always read as '1'. Example 11-1 shows how to initialize an I/O port.

Reading the PORTA register (Register 11-2) reads the status of the pins, whereas writing to it will write to the PORT latch. All write operations are Read-Modify-Write operations. Therefore, a write to a port implies that the port pins are read, this value is modified and then written to the Port Data Latch (LATA).

11.3.2 DIRECTION CONTROL

The TRISA register (Register 11-3) controls the PORTA pin output drivers, even when they are being used as analog inputs. The user should ensure the bits in the TRISA register are maintained set when using them as analog inputs. I/O pins configured as analog input always read '0'.

11.3.3 OPEN-DRAIN CONTROL

The ODCONA register (Register 11-7) controls the open-drain feature of the port. Open-drain operation is independently selected for each pin. When an ODCONA bit is set, the corresponding port output becomes an open-drain driver capable of sinking current only. When an ODCONA bit is cleared, the corresponding port output pin is the standard push-pull drive capable of sourcing and sinking current.

11.3.4 SLEW RATE CONTROL

The SLRCONA register (Register 11-8) controls the slew rate option for each port pin. Slew rate control is independently selectable for each port pin. When an SLRCONA bit is set, the corresponding port pin drive is slew rate limited. When an SLRCONA bit is cleared, the corresponding port pin drive slews at the maximum rate possible.

11.3.5 INPUT THRESHOLD CONTROL

The INLVLA register (Register 11-9) controls the input voltage threshold for each of the available PORTA input pins. A selection between the Schmitt Trigger CMOS or the TTL compatible thresholds is available. The input threshold is important in determining the value of a read of the PORTA register and also the level at which an Interrupt-On-Change occurs, if that feature is enabled. See **Section 26.3 "DC Characteristics"** for more information on threshold levels.

Note: Changing the input threshold selection should be performed while all peripheral modules are disabled. Changing the threshold level during the time a module is active may inadvertently generate a transition associated with an input pin, regardless of the actual voltage level on that pin.

11.3.6 ANALOG CONTROL

The ANSELA register (Register 11-5) is used to configure the Input mode of an I/O pin to analog. Setting the appropriate ANSELA bit high will cause all digital reads on the pin to be read as '0' and allow analog functions on the pin to operate correctly.

The state of the ANSELA bits has no effect on digital output functions. A pin with TRIS clear and ANSELA set will still operate as a digital output, but the Input mode will be analog. This can cause unexpected behavior when executing Read-Modify-Write instructions on the affected port.

Note: The ANSELA bits default to the Analog mode after Reset. To use any pins as digital general purpose or peripheral inputs, the corresponding ANSELA bits must be initialized to '0' by user software.

EXAMPLE 11-1: INITIALIZING PORTA

```
BANKSEL PORTA      ;
CLRF PORTA          ;Init PORTA
BANKSEL LATA        ;Data Latch
CLRF LATA           ;
BANKSEL ANSELA      ;
CLRF ANSELA         ;digital I/O
BANKSEL TRISA       ;
MOVLW B'00111000'   ;Set RA<5:3> as inputs
MOVWF TRISA         ;and set RA<2:0> as
                   ;outputs
```

13.0 FIXED VOLTAGE REFERENCE (FVR)

The Fixed Voltage Reference (FVR) is a stable voltage reference, independent of V_{DD} , with a nominal output level (V_{FVR}) of 1.024V. The output of the FVR can be configured to supply a reference voltage to the following:

- ADC input channel
- Comparator positive input
- Comparator negative input

The FVR can be enabled by setting the FVREN bit of the FVRCON register.

13.1 Independent Gain Amplifier

The output of the FVR supplied to the peripherals, (listed above), is routed through a programmable gain amplifier. Each amplifier can be programmed for a gain of 1x, 2x or 4x, to produce the three possible voltage levels.

The ADFVR<1:0> bits of the FVRCON register are used to enable and configure the gain amplifier settings for the reference supplied to the ADC module. Reference **Section 15.0 “Analog-to-Digital Converter (ADC) Module”** for additional information.

The CDAFVR<1:0> bits of the FVRCON register are used to enable and configure the gain amplifier settings for the reference supplied to the comparator modules. Reference **Section 17.0 “Comparator Module”** for additional information.

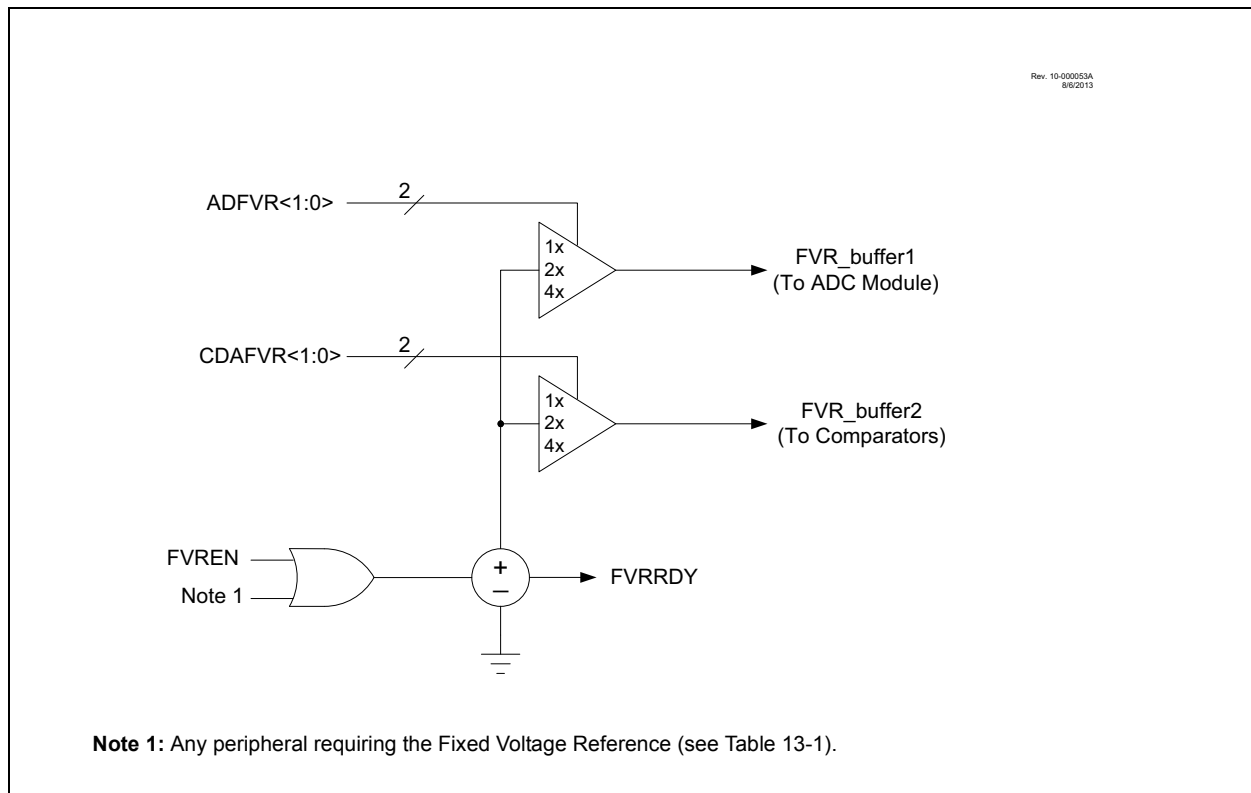
To minimize current consumption when the FVR is disabled, the FVR buffers should be turned off by clearing the Buffer Gain Selection bits.

13.2 FVR Stabilization Period

The FVR can be enabled by setting the FVREN bit of the FVRCON register.

When the Fixed Voltage Reference module is enabled, it requires time for the reference and amplifier circuits to stabilize. Once the circuits stabilize and are ready for use, the FVRRDY bit of the FVRCON register will be set. See the FVR Stabilization Period characterization graph, Figure 27-21.

FIGURE 13-1: VOLTAGE REFERENCE BLOCK DIAGRAM



15.3 Register Definitions: ADC Control

REGISTER 15-1: ADCON0: ADC CONTROL REGISTER 0

U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	CHS<4:0>					GO/DONE	ADON
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

u = Bit is unchanged

x = Bit is unknown

U = Unimplemented bit, read as '0'

'1' = Bit is set

'0' = Bit is cleared

-n/n = Value at POR and BOR/Value at all other Resets

bit 7 **Unimplemented:** Read as '0'

bit 6-2 **CHS<4:0>:** Analog Channel Select bits

00000 = AN0

00001 = AN1

00010 = AN2

00011 = AN3

00100 = Reserved; no channel connected

•

•

•

11100 = Reserved; no channel connected

11101 = Temperature indicator⁽¹⁾

11110 = DAC (Digital-to-Analog Converter)⁽²⁾

11111 = FVR (Fixed Voltage Reference) Buffer 1 output⁽³⁾

bit 1 **GO/DONE:** ADC Conversion Status bit

1 = ADC conversion cycle is in progress

Setting this bit starts an ADC conversion cycle. This bit is automatically cleared by hardware when the ADC conversion has completed.

0 = ADC conversion completed/not in progress

bit 0 **ADON:** ADC Enable bit

1 = ADC is enabled

0 = ADC is disabled and consumes no operating current

Note 1: See **Section 14.0 “Temperature Indicator Module”** for more information.

2: See **Section 16.0 “5-Bit Digital-to-Analog Converter (DAC) Module”** for more information.

3: See **Section 13.0 “Fixed Voltage Reference (FVR)”** for more information.

PIC12(L)F1571/2

NOTES:

19.6 Timer1 Interrupt

The Timer1 register pair (TMR1H:TMR1L) increments to FFFFh and rolls over to 0000h. When Timer1 rolls over, the Timer1 interrupt flag bit of the PIR1 register is set. To enable the interrupt on rollover, you must set these bits:

- TMR1ON bit of the T1CON register
- TMR1IE bit of the PIE1 register
- PEIE bit of the INTCON register
- GIE bit of the INTCON register

The interrupt is cleared by clearing the TMR1IF bit in the Interrupt Service Routine.

Note: The TMR1H:TMR1L register pair and the TMR1IF bit should be cleared before enabling interrupts.

The device will wake-up on an overflow and execute the next instructions. If the GIE bit of the INTCON register is set, the device will call the Interrupt Service Routine.

Timer1 oscillator will continue to operate in Sleep regardless of the T1SYNC bit setting.

19.7.1 ALTERNATE PIN LOCATIONS

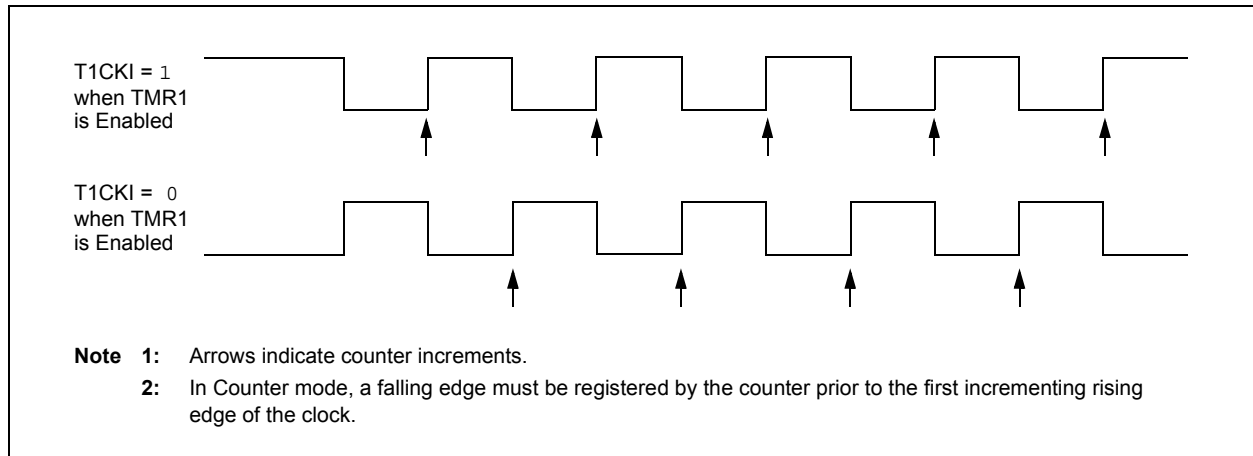
This module incorporates I/O pins that can be moved to other locations with the use of the Alternate Pin Function register, APFCON. To determine which pins can be moved and what their default locations are upon a Reset, see **Section 11.1 “Alternate Pin Function”** for more information.

19.7 Timer1 Operation During Sleep

Timer1 can only operate during Sleep when set up in Asynchronous Counter mode. In this mode, an external crystal or clock source can be used to increment the counter. To set up the timer to wake the device:

- TMR1ON bit of the T1CON register must be set
- TMR1IE bit of the PIE1 register must be set
- PEIE bit of the INTCON register must be set
- T1SYNC bit of the T1CON register must be set
- TMR1CS bits of the T1CON register must be configured

FIGURE 19-2: TIMER1 INCREMENTING EDGE



22.2 PWM Modes

PWM modes are selected with the MODE<1:0> bits of the PWMxCON register (Register 22-1).

In all PWM modes, an offset match event can also be used to synchronize the PWMxTMR in three Offset modes. See **Section 22.3 “Offset Modes”** for more information.

22.2.1 STANDARD MODE

The Standard mode (MODE<1:0> = 00) selects a single-phase PWM output. The PWM output in this mode is determined by when the period, duty cycle and phase counts match the PWMxTMR value. The start of the duty cycle occurs on the phase match and the end of the duty cycle occurs on the duty cycle match. The period match resets the timer. The offset match can also be used to synchronize the PWMxTMR in the Offset modes. See **Section 22.3 “Offset Modes”** for more information.

Equation 22-1 is used to calculate the PWM period in Standard mode.

Equation 22-2 is used to calculate the PWM duty cycle ratio in Standard mode.

EQUATION 22-1: PWM PERIOD IN STANDARD MODE

$$Period = \frac{(PWMxPR + 1) \cdot Prescale}{PWMxCLK}$$

EQUATION 22-2: PWM DUTY CYCLE IN STANDARD MODE

$$Duty\ Cycle = \frac{(PWMxDC - PWMxPH)}{PWMxPR + 1}$$

A detailed timing diagram for Standard mode is shown in Figure 22-4.

22.2.2 SET ON MATCH MODE

The Set On Match mode (MODE<1:0> = 01) generates an active output when the phase count matches the PWMxTMR value. The output stays active until the OUT bit of the PWMxCON register is cleared or the PWM module is disabled. The duty cycle count has no effect in this mode. The period count only determines the maximum PWMxTMR value above which no phase matches can occur.

The OUT bit can be used to set or clear the output of the PWM in this mode. Writes to this bit will take place on the next rising edge of the PWM_clock after the bit is written.

A detailed timing diagram for Set On Match mode is shown in Figure 22-5.

22.2.3 TOGGLE ON MATCH MODE

The Toggle On Match mode (MODE<1:0> = 10) generates a 50% duty cycle PWM with a period twice as long as that computed for the Standard PWM mode. Duty cycle count has no effect in this mode. The phase count determines how many PWMxTMR periods, after a period event, the output will toggle.

Writes to the OUT bit of the PWMxCON register will have no effect in this mode.

A detailed timing diagram for Toggle On Match mode is shown in Figure 22-6.

22.2.4 CENTER-ALIGNED MODE

The Center-Aligned mode (MODE = 11) generates a PWM waveform that is centered in the period. In this mode, the period is two times the PWMxPR count. The PWMxTMR counts up to the period value, then counts back down to 0. The duty cycle count determines both the start and end of the active PWM output. The start of the duty cycle occurs at the match event when PWMxTMR is incrementing and the duty cycle ends at the match event when PWMxTMR is decrementing. The incrementing match value is the period count minus the duty cycle count. The decrementing match value is the incrementing match value plus 1.

Equation 22-3 is used to calculate the PWM period in Center-Aligned mode.

EQUATION 22-3: PWM PERIOD IN CENTER-ALIGNED MODE

$$Period = \frac{(PWMxPR + 1) \cdot Prescale \cdot 2}{PWMxCLK}$$

Equation 22-4 is used to calculate the PWM duty cycle ratio in Center-Aligned mode.

EQUATION 22-4: PWM DUTY CYCLE IN CENTER-ALIGNED MODE

$$Duty\ Cycle = \frac{PWMxDC \cdot 2}{(PWMxPR + 1) \cdot 2}$$

Writes to the OUT bit will have no effect in this mode.

A detailed timing diagram for Center-Aligned mode is shown in Figure 22-7.

FIGURE 22-6: TOGGLE ON MATCH PWM MODE TIMING DIAGRAM

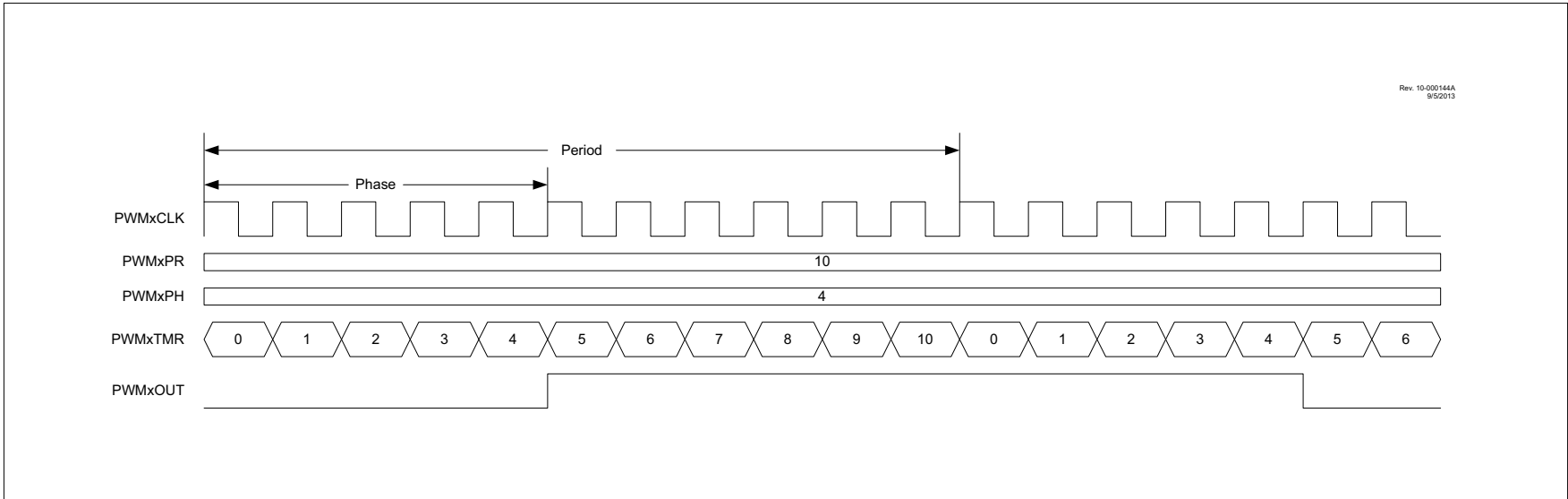
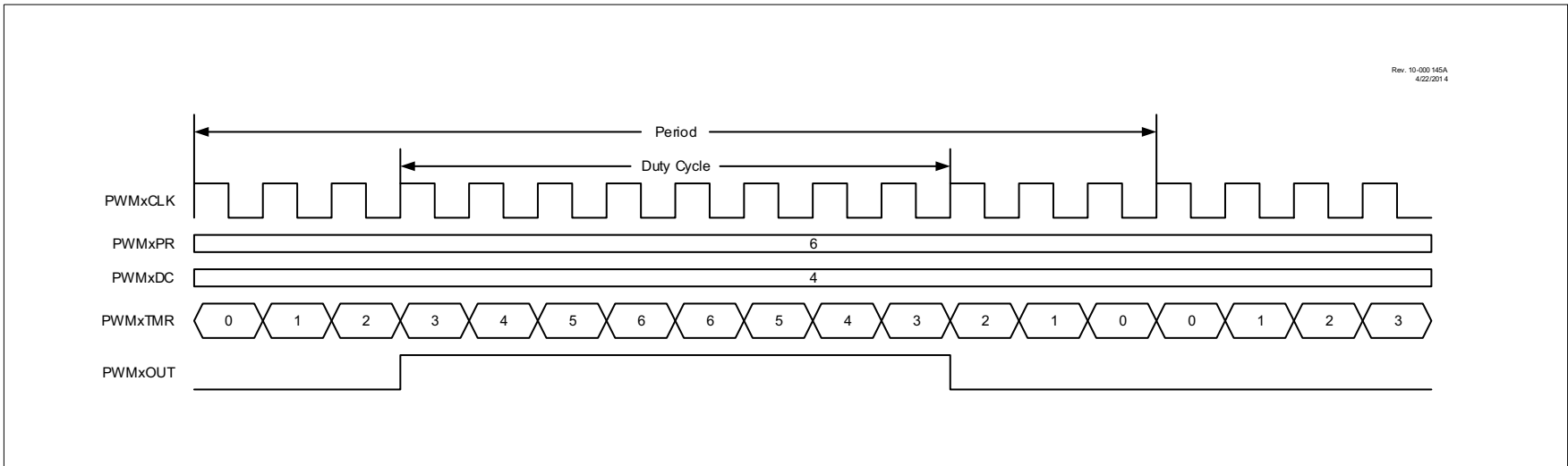


FIGURE 22-7: CENTER-ALIGNED PWM MODE TIMING DIAGRAM



REGISTER 22-6: PWMxOFCON: PWMx OFFSET TRIGGER SOURCE SELECT REGISTER

U-0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0	R/W-0/0	R/W-0/0
—	OFM<1:0>		OFO ⁽¹⁾	—	—	OFS<1:0>	
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	
u = Bit is unchanged	x = Bit is unknown	U = Unimplemented bit, read as '0'
'1' = Bit is set	'0' = Bit is cleared	-n/n = Value at POR and BOR/Value at all other Resets

bit 7 **Unimplemented:** Read as '0'

bit 6-5 **OFM<1:0>:** Offset Mode Select bits

11 = Continuous Slave Run mode with immediate Reset and synchronized start when the selected offset trigger occurs

10 = One-Shot Slave Run mode with synchronized start when the selected offset trigger occurs

01 = Independent Slave Run mode with synchronized start when the selected offset trigger occurs

00 = Independent Run mode

bit 4 **OFO:** Offset Match Output Control bit⁽¹⁾

If MODE<1:0> = 11 (PWM Center-Aligned mode):

1 = OFx_match occurs on counter match when counter decrementing, (second match)

0 = OFx_match occurs on counter match when counter incrementing, (first match)

If MODE<1:0> = 00, 01 or 10 (all other modes):

Bit is ignored.

bit 3-2 **Unimplemented:** Read as '0'

bit 1-0 **OFS<1:0>:** Offset Trigger Source Select bits

11 = OF3_match⁽¹⁾

10 = OF2_match⁽¹⁾

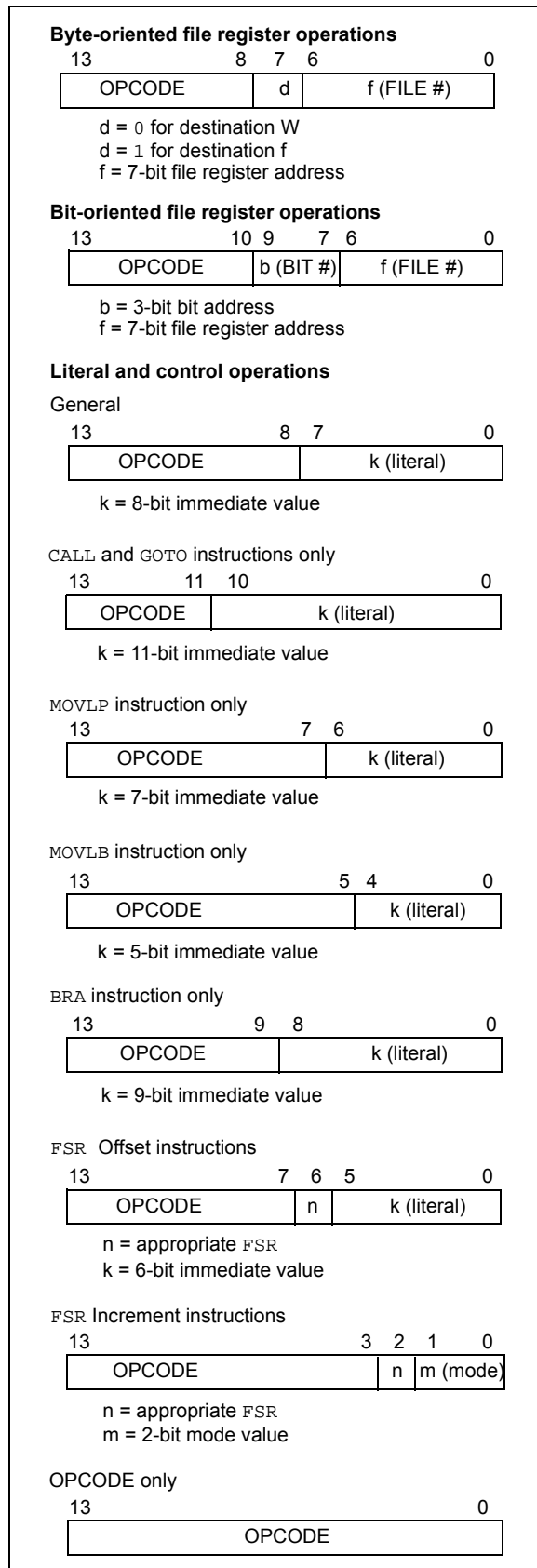
01 = OF1_match⁽¹⁾

00 = Reserved

Note 1: The OFx_match corresponding to the PWM used becomes reserved.

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FIGURE 25-1: GENERAL FORMAT FOR INSTRUCTIONS



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TABLE 25-3: ENHANCED MID-RANGE INSTRUCTION SET (CONTINUED)

Mnemonic, Operands		Description	Cycles	14-Bit Opcode				Status Affected	Notes
				MSb		LSb			
CONTROL OPERATIONS									
BRA	k	Relative Branch	2	11	001k	kkkk	kkkk		
BRW	—	Relative Branch with W	2	00	0000	0000	1011		
CALL	k	Call Subroutine	2	10	0kkk	kkkk	kkkk		
CALLW	—	Call Subroutine with W	2	00	0000	0000	1010		
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk		
RETFIE	k	Return from interrupt	2	00	0000	0000	1001		
RETLW	k	Return with literal in W	2	11	0100	kkkk	kkkk		
RETURN	—	Return from Subroutine	2	00	0000	0000	1000		
INHERENT OPERATIONS									
CLRWDT	—	Clear Watchdog Timer	1	00	0000	0110	0100	\overline{TO} , \overline{PD}	
NOP	—	No Operation	1	00	0000	0000	0000		
OPTION	—	Load OPTION_REG register with W	1	00	0000	0110	0010	\overline{TO} , \overline{PD}	
RESET	—	Software device Reset	1	00	0000	0000	0001		
SLEEP	—	Go into Standby mode	1	00	0000	0110	0011		
TRIS	f	Load TRIS register with W	1	00	0000	0110	0fff		
C COMPILER OPTIMIZED									
ADDFSR	n, k	Add Literal k to FSRn	1	11	0001	0nkk	kkkk	Z	2, 3
MOVIW	n mm	Move Indirect FSRn to W with pre/post inc/dec modifier, mm	1	00	0000	0001	0nmm kkkk		
MOVWI	k[n]	Move INDFn to W, Indexed Indirect.	1	11	1111	0nkk	1nmm	Z	2, 3
	n mm	Move W to Indirect FSRn with pre/post inc/dec modifier, mm	1	00	0000	0001	kkkk		
	k[n]	Move W to INDFn, Indexed Indirect.	1	11	1111	1nkk			2

Note 1: If the Program Counter (PC) is modified, or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

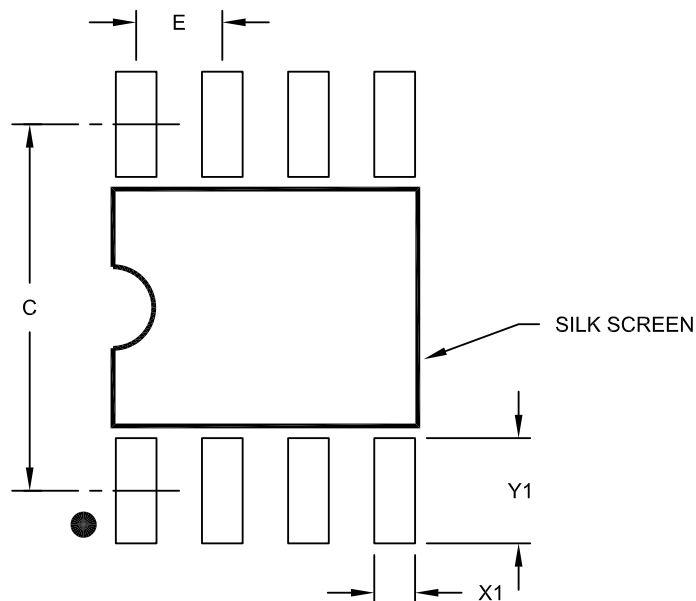
2: If this instruction addresses an INDF register and the MSb of the corresponding FSR is set, this instruction will require one additional instruction cycle.

3: See the table in the MOVIW and MOVWI instruction descriptions.

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8-Lead Plastic Small Outline (SN) – Narrow, 3.90 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	1.27 BSC		
Contact Pad Spacing	C		5.40	
Contact Pad Width (X8)	X1			0.60
Contact Pad Length (X8)	Y1			1.55

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2057A

APPENDIX A: DATA SHEET REVISION HISTORY

Revision A (10/2013)

Original release of this document.

Revision B (2/2014)

Updated PIC12(L)F1571/2 Family Types table
Program Memory Flash heading (*words* to *K words*).

Revision C (8/2014)

Updated PWM chapter. Changed to Final data sheet.
Updated IDD and IPD parameters in the Electrical
Specification chapter. Added Characterization Graphs.

Added Section 1.1: Register and Bit Naming
Conventions.

Updated Figures 5-3 and 15-5. Updated Tables 3-1,
3-7, and 3-10. Updated Section 15.2.5. Updated Equa-
tion 15-1.

Revision D (8/2015)

Updated Clocking Structure, Memory, Low-Power
Features, Family Types table and Pin Diagram Table
on cover pages.

Added Sections 3.2: High-Endurance Flash and
5.4: Clock Switching Before Sleep. Added Table 29-2
and 8-pin UDFN packaging.

Updated Examples 3-2 and 15-1.

Updated Figures 8-1, 21-1, 22-8 through 22-13 and
23-1.

Updated Registers 7-5, 8-1, 22-6 and 23-3.

Updated Sections 8.2.2, 15.2.6, 16.0, 21.0, 21.4.2,
22.3.3, 23.9.1.2, 23.11.1, 26.1 and 29.1.

Updated Tables 1, 3-3, 3-4, 3-10, 5-1, 16-1, 17-3, 22-2,
23-2, 26-6, 26-8 and 29-1.